



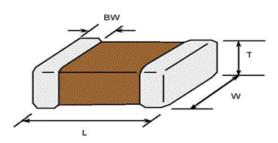
SPECIFICATION

(Reference sheet)

- · Supplier : Samsung electro-mechanics
- · Product : Multi-layer Ceramic Capacitor
- · Samsung P/N :
- CL32B103KGFNNNF

- A. Samsung Part Number
- · Description :
- CAP, 10nF, 500V, ±10%, X7R, 1210
- <u>CL</u> <u>32</u> B <u>103</u> <u>K</u> G E Ν N <u>F</u> Ν 1 2 4 (5) 6 (7) 9 3 (8) (10) (1) Samsung Multi-layer Ceramic Capacitor 1 Series 2 Size $L: 3.20 \pm 0.30$ mm 1210 (inch code) W: 2.50 ± 0.20 mm 3 Dielectric X7R (8) Inner electrode Ni **④** Capacitance 10 nF Termination Cu **5** Capacitance Plating Sn 100% ±10 % (Pb Free) tolerance **9** Product Normal 500 V Reserved for future use 6 Rated Voltage 10 Special Packaging ⑦ Thickness 1.25 ± 0.20 mm 1 Embossed Type, 13" reel

B. Structure & Dimension



Samsung P/N	Dimension(mm)			
	L	W	Т	BW
CL32B103KGFNNNF	3.20 ± 0.30	2.50 ± 0.20	1.25 ± 0.20	0.60 ± 0.30

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition	
Capacitance	Within specified tolerance	1 ^{kHz} ±10% / 1.0±0.2Vrms	
Tan δ (DF)	0.025 max.	*A capacitor prior to measuring the capacitance is heat treated at 150° C+0/-10°C for 1hour and maintained in ambient air for 24±2 hours.	
Insulation	10,000Mohm or 500Mohm×µF	Rated Voltage 60±5 sec.	
Resistance	Whichever is smaller		
Appearance	No abnormal exterior appearance	Microscope (×10)	
Withstanding	No dielectric breakdown or	150% of the rated voltage	
Voltage	mechanical breakdown		
Temperature	X7R		
Characteristics	(From -55℃ to 125℃, Capacitance change	should be within ±15%)	
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.	
of Termination	terminal electrode		
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm) with 1.0mm/sec.	
Solderability	More than 95% of terminal surface	SnAg3.0Cu0.5 solder	
	is to be soldered newly	245±5°C, 3±0.3sec.	
		(preheating : 80∼120℃ for 10~30sec.)	
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5°C, 10±1sec.	
Soldering Heat	Tan δ, IR : initial spec.		
Vibration Test	Capacitance change : within ± 5%	Amplitude : 1.5mm	
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)	
		2hours × 3 direction (x, y, z)	
Moisture	Capacitance change : within ±12.5%	With rated voltage	
Resistance	Tan δ : 0.05 max	40±2℃, 90~95%RH, 500+12/-0hrs	
	IR : 500Mohm or 25Mohm × μ F		
	Whichever is smaller		
High Temperature	Capacitance change : within ±12.5%	With 150% of the rated voltage	
Resistance	Tan δ : 0.05 max	Max. operating temperature	
	IR : 1,000Mohm or 50Mohm × <i>µ</i> F	1,000+48/-0hrs	
	Whichever is smaller		
Temperature	Capacitance change : within ±7.5%	1 cycle condition	
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25°C	
		→ Max. operating temperature → 25° C	
		5 cycle test	

% The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 250 °C, 6 sec max.)

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury. We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- *①* Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- (4) Military equipment
- 5 Disaster prevention/crime prevention equipment
- Ø Power plant control equipment
- ⑦ Atomic energy-related equipment
- Indersea equipment
- Itraffic signal equipment
- Data-processing equipment
- ① Electric heating apparatus, burning equipment
- ② Safety equipment
- 13 Any other applications with the same as or similar complexity or reliability to the applications